PHE429 Series Single Metallized Polypropylene Film, Optimized for SMPS PFC Applications



Overview

The PHE429 Series is a metallized polypropylene film encapsulated with self-extinguishing resin in a box of material meeting the requirements of UL 94 V–0.

Applications

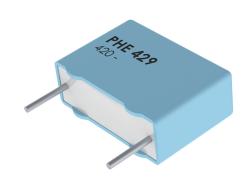
Typical applications include power factor correction and pulse applications.

Benefits

- Rated voltage: 420 630 VDC
- Rated voltage: 220 275 VAC
- Capacitance range: 0.047 0.47 µF
- · Lead spacing: 15 mm
- · Capacitance tolerance: ±10%, other tolerances on request
- Climatic category: 55/110/56, IEC 60068-1
- Tape and reel packaging in accordance with IEC 60286-2
- · RoHS Compliant and lead-free terminations

Legacy Part Number System

Category temperature range of -55°C to +110°C



PHE429	К	В	6100	К	R06
Series	Rated Voltage (VDC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
Metallized Polypropylene	K = 420 M = 630	B = 15.0	The last three digits represent significant figures. First digit specifies the number of zeros to be added.	K = ±10% Other tolerances on request	See Ordering Options Table

New KEMET Part Number System

F	429	В	D	104	K	420	С
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Packaging
F = Film	Metallized Polypropylene	B = 15.0	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	K = ±10% Other tolerances on request	420 = 420 630 = 630	See Ordering Options Table

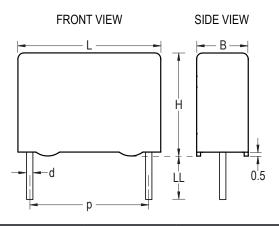
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Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06
	Bulk (Bag) – Max Length Leads	30 +5/-0	A	R30
15	Other Lead and Packaging Options			
	Bulk (Bag) – Max Length Leads	30 +5/-0	ALW0L	R30
	Tape & Reel (Standard Reel)	H ₀ = 18.5 +/-0.5	L	R17T0
	Tape & Reel (Large Reel)	H ₀ = 18.5 +/-0.5	Р	R17T1
Native 15	Ammo Pack	H ₀ = 16.5 +/-0.5	XLAF1	R25XA
formed to 7.5	Tape & Reel (Standard Reel)	H ₀ = 16.5 +/-0.5	XLTF1	R25X2

Dimensions – Millimeters



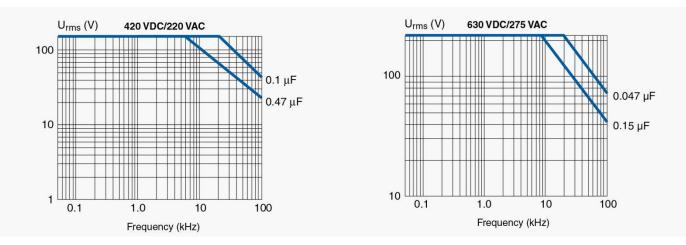
KEMET Size	e Legacy Size Code	р		В		Н		L		d	
Code		Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
BD	B04	15	+/-0.4	5.5	Maximum	10.5	Maximum	18	Maximum	0.8	+/-0.05
BG	B15	15	+/-0.4	6	Maximum	12	Maximum	18	Maximum	0.8	+/-0.05
BJ	B10	15	+/-0.4	6.5	Maximum	12.5	Maximum	18	Maximum	0.8	+/-0.05
BL	B06	15	+/-0.4	7.5	Maximum	14.5	Maximum	18	Maximum	0.8	+/-0.05
BM	B12	15	+/-0.4	8	Maximum	15	Maximum	18	Maximum	0.8	+/-0.05
		No	te: See Ordei	ring Options	Table for lea	d length (LL) options.				



Performance Characteristics

Voltage Range (VDC)	420	630						
Voltage Range (VAC)	220	275						
Capacitance Range (µF)	0.1 – 0.47	0.047 – 0.15						
Capacitance Tolerance	±10%, other tolerances on request							
Category Temperature Range	-55°C to +110°C							
Rated Temperature	+85°C							
Voltage Derating	The rated voltage is decreased with 1.3%/°C between +85°C and +110°C							
Climatic Category	IEC 60068–1, 55/110/56							
Maximum Pulse Steepness	dV/dt according to Table 1. For peak to peak voltages lower than rated voltage ($V_{pp} < V_{R}$), the specified dV/dt can be multiplied by the factor V_{R}/V_{pp} .							
Self-Inductance	Approximately 6 nH/cm for the total leng	th of capacitor winding and the leads						
Dissinction Easter tan S	Maximum Values at +23°C							
Dissipation Factor tanδ	1 kHz	0.001						
	Measured at +23°C, 100 VDC 60 secon at 500 VDC for $V_R \ge 500$ VDC	ds for V_{R} < 500 VDC and						
	Minimum Values E	Between Terminals						
Insulation Resistance	C ≤ 0.33 µF	≥ 100,000 MΩ						
	C > 0.33 μF	≥ 30,000 MΩ • μF						
	Minimum Values Between Terminals and Case							
		≥ 100,000 MΩ						

Derating of V_{RMS} vs. Frequency, +85°C Ambient Temperature and 10°C Internal Heating, Typical Values





Environmental Test Data

Test	IEC Publication	Procedure	Requirements
Voltage Proof	60384–1 Clause 4.6	1.6 x V _R after 60 seconds	The capacitors must withstand the voltage without breakdowns or flashovers and without decreased insulation resistance below the value in each detail specification. No visible damage
	Clause 4.6 2.3 2 x V _R (minimum 400 VDC to case) after 60 seconds		As above
Vibration	60068–2–6 Test Fc	6 hours with 10 – 500 Hz and 0.75 mm amplitude or 98 m/s ² depending on frequency	No visible damage tan $\delta \le 1.2$ x stated value at 100 kHz Δ C/C $\le \pm 0.5$ %
Bump	60068–2–29 Test Eb	4,000 bumps with 390 m/s ² mounted on PCB	$\Delta C/C \le \pm 0.5\%$ tan $\delta \le 1.2$ x stated value at 100 kHz Insulation resistance: $\ge 100,000 \text{ M}\Omega \text{ for } C_R \le 0.33 \mu\text{F}$ $\ge 30,000 M\Omega \cdot \mu\text{F} \text{ for } C_R > 0.33 \mu\text{F}$
Resistance to Soldering Heat	60068–2–20 Method 1A	Solder bath at + 260°C ±5°C with screening	Immersion of the terminations into the solder bath shall be completed in a time not exceeding 1 second and the terminations shall remain immersed to the specified depth for 10 + 1 second and then be withdrawn. $\Delta C/C \le \pm 1.0\%$ tan δ increase < 0.001 No visible damage
Climatic Sequence	60384–1 Paragraph 4:21	60068–2.2 dry heat 16 hours 60068–2–34 damp heat, one cycle 60068–2–1 Test Aa 2 hours	Insulation resistance: $\geq 100,000 \text{ M}\Omega \text{ for } C_R \leq 0.33 \mu\text{F}$ $\geq 30,000 \text{ M}\Omega \cdot \mu\text{F for } C_R > 0.33 \mu\text{F}$ $\Delta C/C \leq \pm 0.5\%$ $\tan \delta \leq 1.2 \text{ x stated value at 100 kHz}$
Damp Heat Steady State	60068–2–3 Test Ca	+40°C and 90 – 95% RH	56 days no visible damage Insulation resistance: ≥ 50,000 MΩ for C _R ≤ 0.33 μF ≥ 15,000 MΩ • μF for C _R > 0.33 μF Δ C/C ≤ ±1% tanδ ≤ 1.2 x stated value at 100 kHz
Endurance, AC		1,000 hours at +85°C and 1.25 x V _R AC	No visible damage $\Delta C/C \le \pm 3\%$ tan $\delta \le 1.5 \times$ stated value at 100 kHz Insulation resistance: $\ge 100,000 \text{ M}\Omega \text{ for } C_R \le 0.33 \mu\text{F}$ $\ge 30,000 \text{ M}\Omega \cdot \mu\text{F for } C_R > 0.33 \mu\text{F}$
Charge and Discharge	60384–17 Paragraph 4.13	10,000 pulses and with (2 x) dV/dt according to detail specification	tan δ (100 kHz) $\leq 2 \times$ stated value (100 kHz) Δ C/C $\leq \pm 0.5\%$ Insulation resistance: $\geq 50,000 \text{ M}\Omega \text{ for } C_R \leq 0.33 \mu\text{F}$ $\geq 15,000 \text{ M}\Omega \cdot \mu\text{F for } C_R > 0.33 \mu\text{F}$

Environmental Compliance

All KEMET pulse capacitors are RoHS Compliant.



Table 1 – Ratings & Part Number Reference

VDC	VAC	Cap Value	Dimer	nsions	in mm	Lead	dV/dt	Size Code	R _{thha} °C/W	New Kemet	Legacy Part
VDC	VAC	(µF)	В	Н	L	Space	(V/µs)	(New/Legacy)	85°C 0.2m/s	Part Number	Number
420	220	0.10	5.5	10.5	18.0	15	150	BD/B04	99	F429BD104K420(1)	PHE429KB6100K(1)
420	220	0.15	5.5	10.5	18.0	15	150	BD/B04	99	F429BD154K420(1)	PHE429KB6150K(1)
420	220	0.22	6.0	12.0	18.0	15	150	BG/B15	83	F429BG224K420(1)	PHE429KB6220K(1)
420	220	0.33	7.5	14.5	18.0	15	150	BL/B06	74	F429BL334K420(1)	PHE429KB6330K(1)
420	220	0.47	8.0	15.0	18.0	15	150	BM/B12	71	F429BM474K420(1)	PHE429KB6470K(1)
630	275	0.047	5.5	10.5	18.0	15	250	BD/B04	99	F429BD473K630(1)	PHE429MB5470K(1)
630	275	0.068	5.5	10.5	18.0	15	250	BD/B04	99	F429BD683K630(1)	PHE429MB5680K(1)
630	275	0.10	5.5	10.5	18.0	15	250	BD/B04	99	F429BD104K630(1)	PHE429MB6100K(1)
630	275	0.15	6.5	12.5	18.0	15	250	BJ/B10	84	F429BJ154K630(1)	PHE429MB6150K(1)
VDC	VAC	Cap Value (µF)	B (mm)	H (mm)	L (mm)	Lead Space	dV/dt (V/µs)	Size Code (New/Legacy)	R _{thha} °C/W 85°C 0.2m/s	New KEMET Part Number	Legacy Part Number

(1) Insert lead and packaging code. See Ordering Options Table for available options.



Soldering Process

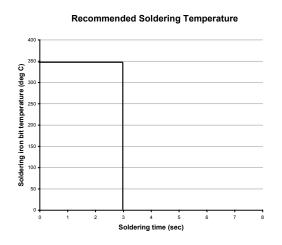
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 - 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 - 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert throughhole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

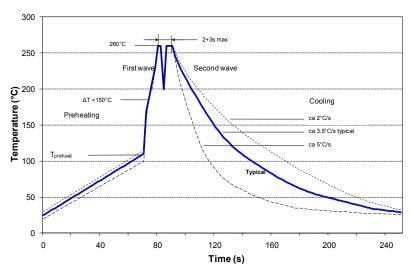
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations





Soldering Process cont'd

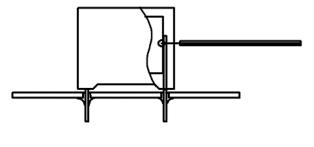
Wave Soldering Recommendations cont'd

1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature		
Film Material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

The maximum temperature measured inside the capacitor: Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

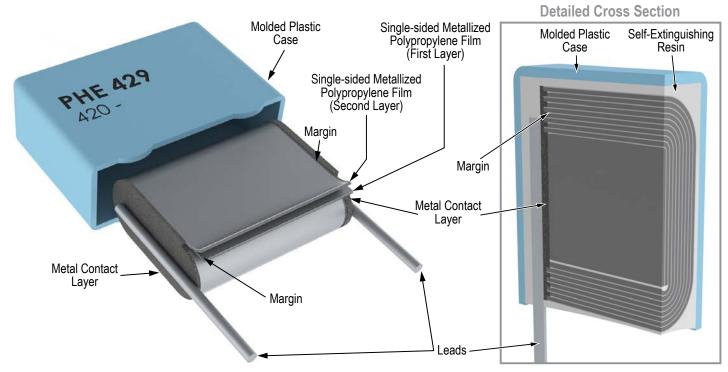
Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, however, instead of two baths, there is only one bath with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.

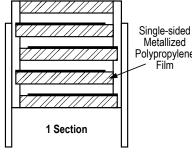
General Purpose, Pulse and DC Transient Suppression – PHE429 Series Single Metallized Polypropylene Film, for SMPS PFC Applications



Construction



Winding Scheme



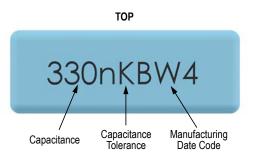
Polypropylene Film

General Purpose, Pulse and DC Transient Suppression – PHE429 Series Single Metallized Polypropylene Film, for SMPS PFC Applications



Marking



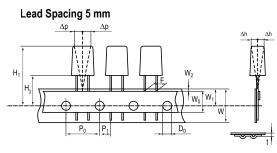


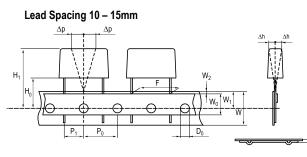
Packaging Quantities

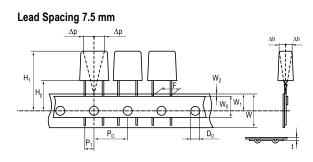
KEMET Size Code	Legacy Size Code	Lead Spacing	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 360 mm	Large Reel ø 500 mm	Standard Reel Formed	Ammo Formed
BD	B04		5.5	10.5	18	1000	800	600	1200	550	570
BE	B05		5.5	12.5	18	1000	800	600	1200	550	570
BL	B06		7.5	14.5	18	800	400	400	800	350	378
BJ	B10		6.5	12.5	18	1000	600	500	1000	450	480
BQ	B11	15	8.5	16	18	600	400	400	800	350	324
BM	B12	10	8	15	18	600	400	400	800	350	351
BV	B14		9.5	17.5	18	500	300	350	700	250	297
BG	B15		6	12	18	1000	800	500	1000	450	520
BY	B16		11	19	18	450	250	300	600	250	252
BU	B17		13	12.5	18	400	300	250	500	200	216



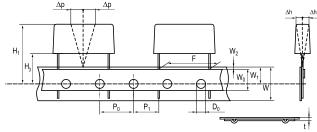
Lead Taping & Packaging (IEC 60286-2)



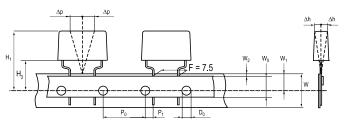




Lead Spacing 22.5 – 27.5 mm



Formed Leads from 10 and 15 mm to 7.5 mm



Taping Specification

	Dimensions in mm											
Lead spacing	+6/-0.1	+6/-0.1 F 5 7.5 Formed 7.5 10 15 22.5 27.5										
Carrier tape width	+/-0.5	W	18	18	18	18	18	18	18	18+1/-0.5		
Hold-down tape width	+/-0.3	W ₀	9	9	9	12	12	12	12			
Position of sprocket hole	+/-0.5	W_1	9	9	9	9	9	9	9	9+0.75/-0.5		
Distance between tapes	Maximum	W_2	3	3	3	3	3	3	3	3		
Sprocket hole diameter	+/-0.2	D ₀	4	4	4	4	4	4	4	4		
Feed hole lead spacing	+/-0.3	P ₀ ⁽¹⁾	12.7	12.7	12.7(4)	12.7	12.7	12.7	12.7	12.7		
Distance lead – feed hole	+/-0.7	P ₁	3.85	3.75	3.75	7.7	5.2	5.3	5.3	P ¹		
Deviation tape – plane	Maximum	Δp	1.3	1.3	1.3	1.3	1.3	1.3	1.3	1.3		
Lateral deviation	Maximum	Δh	2	2	2	2	2	2	2	2		
Total thickness	+/-0.2	t	0.7	0.7	0.7	0.7	0.7	0.9 ^{max}	0.9 ^{max}	0.9 ^{max}		
Sprocket hole/cap body	Nominal	H ₀ ⁽²⁾	18.5+/-0.5	18.5+/-0.5	18.5+/-0.5	18.5+/-0.5	18.5+/-0.5	18.5+/-0.5	18.5+/-0.5	18+2/-0		
Sprocket hole/top of cap body	Maximum	H ₁ ⁽³⁾	32	31	43	43	43	58	58	58 ^{max}		

(1) Maximum cumulative feed hole error, 1 mm per 20 parts.

(2) 16.5 mm available on request.

(3) Depending on case size.

(4) 15 mm available on request.

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Lead Taping & Packaging (IEC 60286–2) cont'd

Ammo Specifications

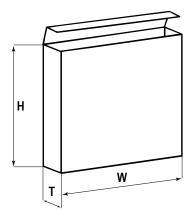
Series	Dimensions (mm)					
Series	Н	W	Т			
R4x, R4x+R, R7x, RSB						
F5A, F5B, F5D	360	340	59			
F6xx, F8xx						
PHExxx, PMExxx, PMRxxx, SMR & PFR	330	330	50			

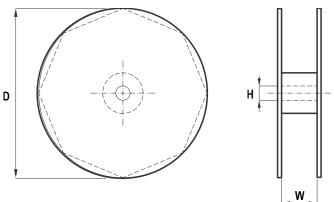
Reel Specifications

Series	Dimensions (mm)		
	D	Н	W
R4x, R4x+R, R7x, RSB	055		
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	500	20	
PHExxx, PMExxx, PMRxxx, SMR & PFR	360 500	30	46 (Max)

Manufacturing Date Code (IEC-60062)

Y = Year, Z = Month				
Year	Code	Month	Code	
2000	М	January	1	
2001	N	February	2	
2002	Р	March	3	
2003	R	April	4	
2004	S	May	5	
2005	Т	June	6	
2006	U	July	7	
2007	V	August	8	
2008	W	September	9	
2009	Х	October	0	
2010	A	November	Ν	
2011	В	December	D	
2012	С			
2013	D			
2014	E			
2015	F			
2016	Н			
2017	J			
2018	К			
2019	L			
2020	М			







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